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## Features

- Glass Passivated Die Construction
- Super-Fast Recovery Time for High Efficiency
- Surge Overload Rating to 100A Peak
- Low Forward Voltage Drop and High Current Capability
- Low Reverse Leakage Current
- Ideally Suited for Automated Assembly
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen- and Antimony-Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](mailto:contact@diodes.com) or your local Diodes representative. <https://www.diodes.com/quality/product-definitions/>**

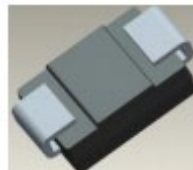
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## Mechanical Data

- Case: SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead-Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 **(Q3)**
- Polarity: Cathode Band
- Weight: 0.093 grams (Approximate)



Top View



Bottom View

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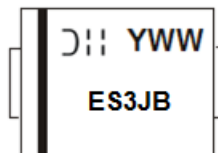
## Ordering Information (Note 4)

Part Number	Qualification	Case	Packaging
ES3JB-13-F	Commercial	SMB	3000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

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## Marking Information



ES3JB = Product Type Marking Code  
 DII = Manufacturers' Code Marking  
 YWW = Date Code Marking  
 Y = Last Digit of Year (ex: 0 for 2020)  
 WW = Week Code (01 to 53)

## Maximum Ratings (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 5)	$V_{RRM}$ $V_{RWM}$ $V_R$	600	V
RMS Reverse Voltage	$V_{R(RMS)}$	420	V
Average Rectified Output Current @ $T_T = +110^\circ\text{C}$	$I_O$	3.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	$I_{FSM}$	100	A

## Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	50	$^\circ\text{C/W}$
Typical Thermal Resistance, Junction to Terminal (Note 6)	$R_{\theta JT}$	15	$^\circ\text{C/W}$
Typical Thermal Resistance, Junction to Case (Note 6)	$R_{\theta JC}$	15	$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150	$^\circ\text{C}$

## Electrical Characteristics (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Max Forward Voltage @ $I_F = 3.0\text{A}$	$V_{FM}$	1.30	V
Peak Reverse Current at Rated DC Blocking Voltage (Note 5)	$I_{RM}$	10 500	$\mu\text{A}$
Typical Total Capacitance (Note 7)	$C_T$	45	pF
Maximum Reverse Recovery Time (Note 8)	$t_{rr}$	35	ns
Typical Reverse Recovery Time	$t_{rr}$	30	ns

- Notes:
5. Short duration pulse test used to minimize self-heating effect.
  6. Unit mounted on PC board with  $5.0\text{mm}^2$  (0.013mm thick) copper pads as heat sink.
  7. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
  8. Measured with  $I_F = 0.5\text{A}$ ,  $I_R = 1.0\text{A}$ ,  $I_{rr} = 0.25\text{A}$ . See Figure 5.

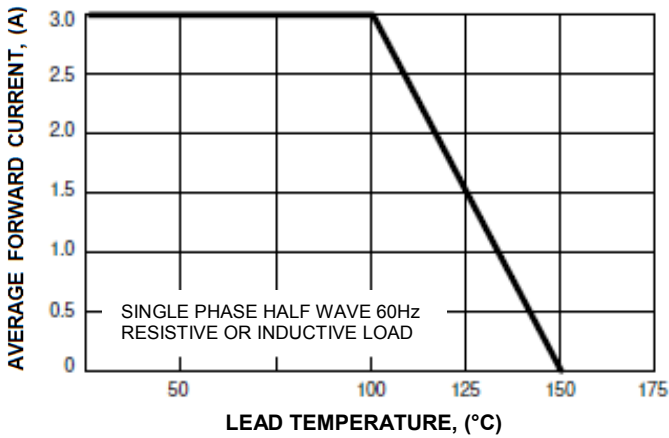


Fig. 1 Forward Current Derating Curve

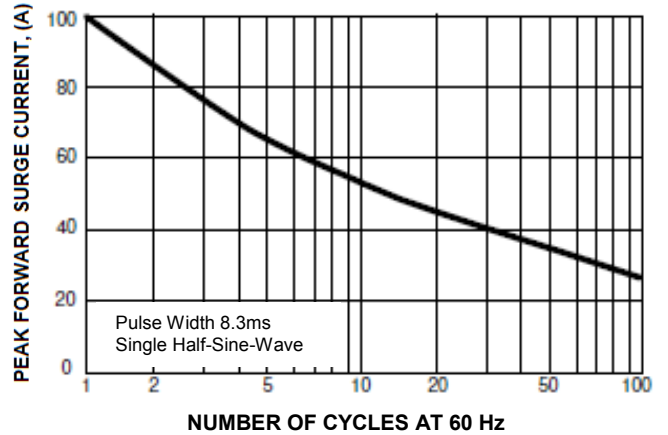


Fig. 2 Maximum Non-Repetitive Surge Current

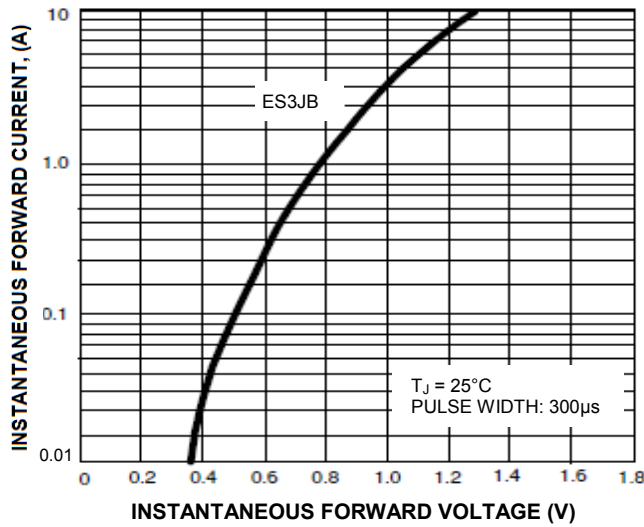


Fig. 3 Typical Forward Characteristics

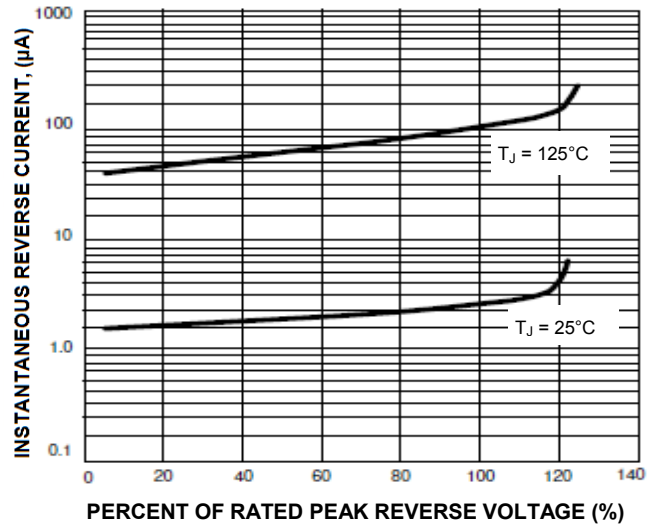
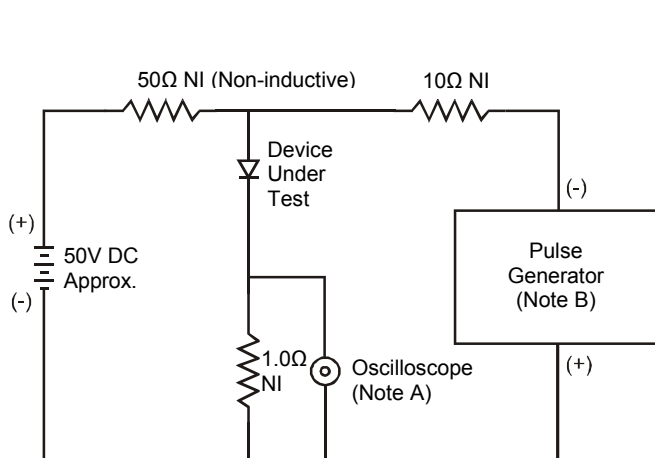


Fig. 4 Typical Reverse Characteristics



Notes:  
A. Rise Time = 7.0ns max. Input Impedance = 1.0 MΩ, 22pF.  
B. Rise Time = 10ns max. Input Impedance = 50Ω.

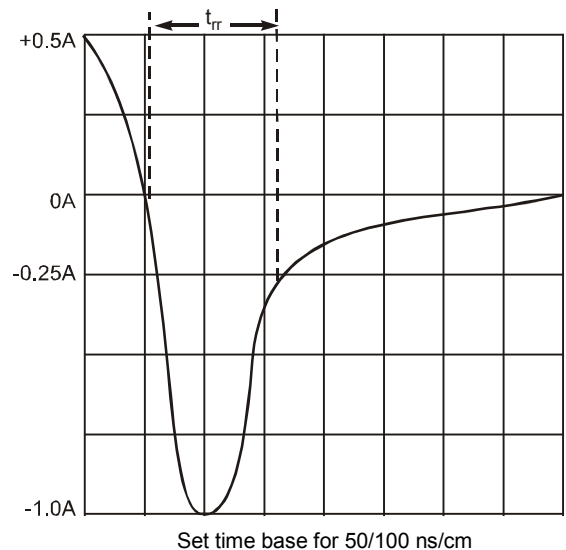
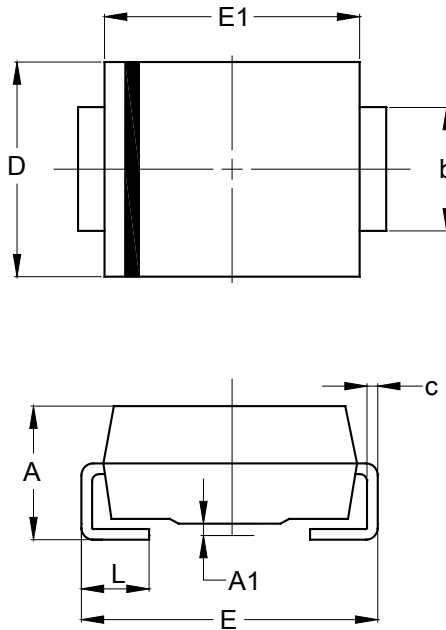


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit

## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### SMB

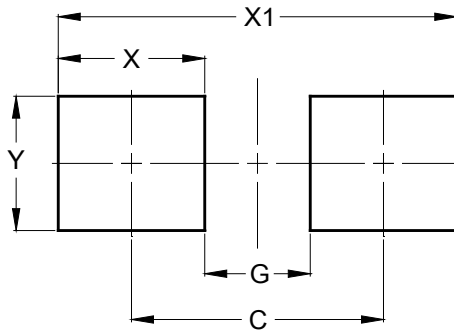


SMB		
Dim	Min	Max
A	2.00	2.50
A1	0.05	0.20
b	1.96	2.21
c	0.15	0.31
D	3.30	3.94
E	5.00	5.59
E1	4.06	4.57
L	0.76	1.52
All Dimensions in mm		

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### SMB



Dimensions	Value (in mm)
C	4.30
G	1.80
X	2.50
X1	6.80
Y	2.30

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